

Power MOSFET

TO-220AB


N-Channel MOSFET

FEATURES

- Dynamic dV/dt rating
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS*
Available

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

PRODUCT SUMMARY

| | | |
|----------------------------|------------------------|-------|
| V _{DS} (V) | 60 | |
| R _{DS(on)} (Ω) | V _{GS} = 10 V | 0.028 |
| Q _g (Max.) (nC) | 67 | |
| Q _{gs} (nC) | 18 | |
| Q _{gd} (nC) | 25 | |
| Configuration | Single | |

ORDERING INFORMATION

| | |
|---------------------------------|---------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRFZ44PbF |
| Lead (Pb)-free and halogen-free | IRFZ44PbF-BE3 |

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

| PARAMETER | | | SYMBOL | LIMIT | UNIT |
|---|-------------------------|-------------------------|-----------------------------------|-------------|----------|
| Drain-source voltage | | | V _{DS} | 60 | V |
| Gate-source voltage | | | V _{GS} | ± 20 | |
| Continuous drain current | V _{GS} at 10 V | T _C = 25 °C | I _D | 50 | A |
| | | T _C = 100 °C | | 36 | |
| Pulsed drain current ^a | | | I _{DM} | 200 | |
| Linear derating factor | | | | 1.0 | W/°C |
| Single pulse avalanche energy ^b | | | E _{AS} | 100 | mJ |
| Maximum power dissipation | T _C = 25 °C | | P _D | 150 | W |
| Peak diode recovery dV/dt ^c | | | dV/dt | 4.5 | V/ns |
| Operating junction and storage temperature range | | | T _J , T _{stg} | -55 to +175 | °C |
| Soldering recommendations (peak temperature) ^d | For 10 s | | | 300 | |
| Mounting torque | 6-32 or M3 screw | | | 10 | lbf · in |
| | | | | 1.1 | N · m |

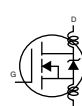
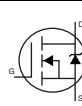
Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- V_{DD} = 25 V, starting T_J = 25 °C, L = 44 μH, R_g = 25 Ω, I_{AS} = 51 A (see fig. 12)
- I_{SD} ≤ 51 A, dI/dt ≤ 250 A/μs, V_{DD} ≤ V_{DS}, T_J ≤ 175 °C
- 1.6 mm from case
- Current limited by the package, (die current = 51 A)

THERMAL RESISTANCE RATINGS

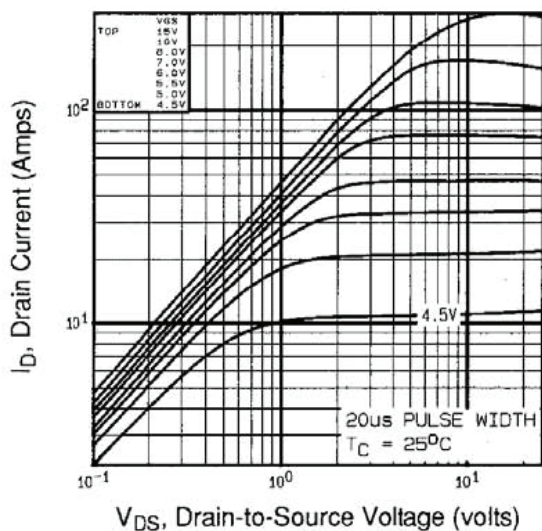
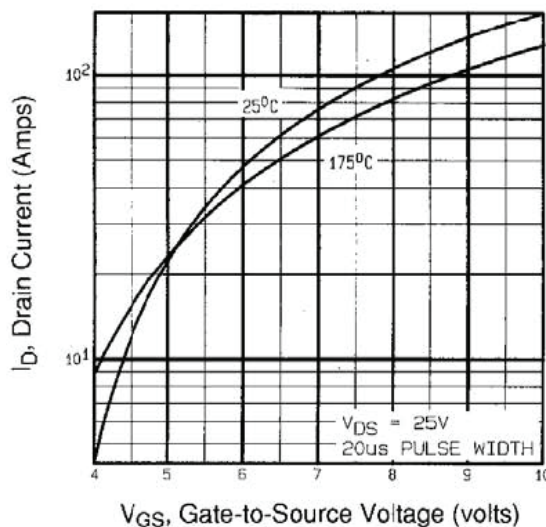
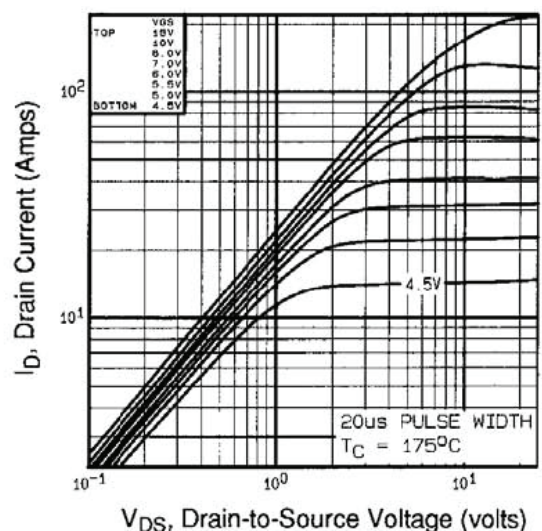
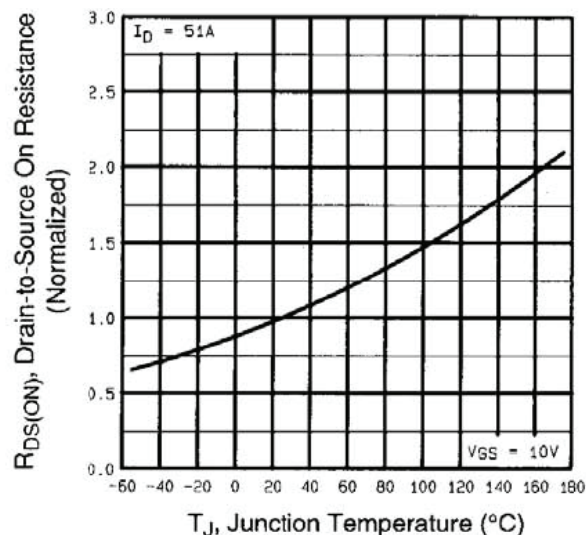
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
|-------------------------------------|------------|------|------|------|
| Maximum junction-to-ambient | R_{thJA} | - | 62 | °C/W |
| Case-to-sink, flat, greased surface | R_{thCS} | 0.50 | - | |
| Maximum junction-to-case (drain) | R_{thJC} | - | 1.0 | |

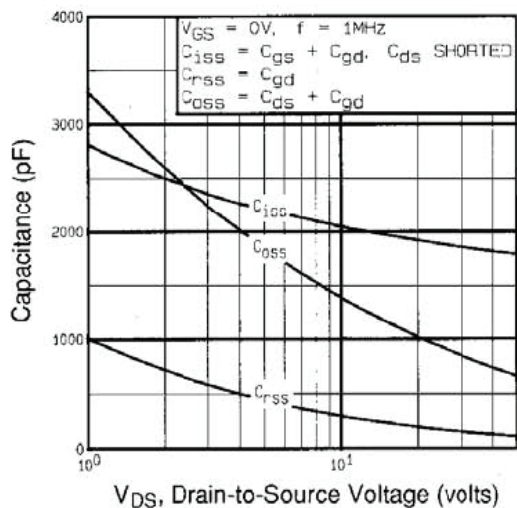
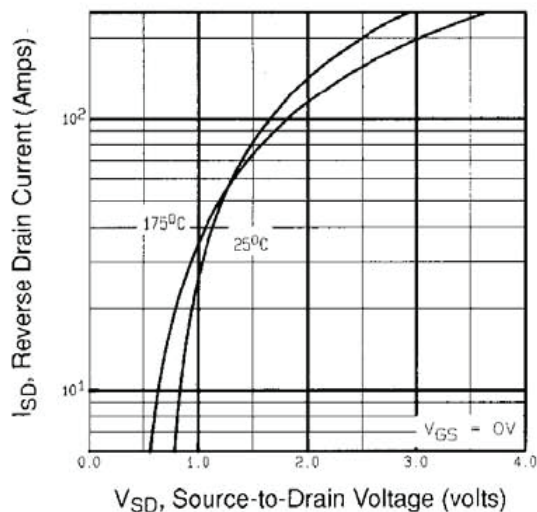
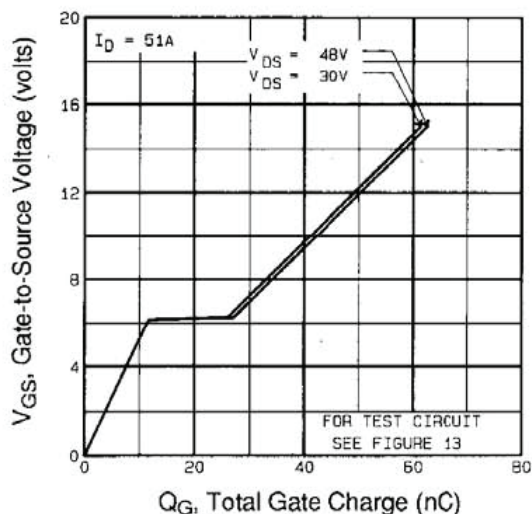
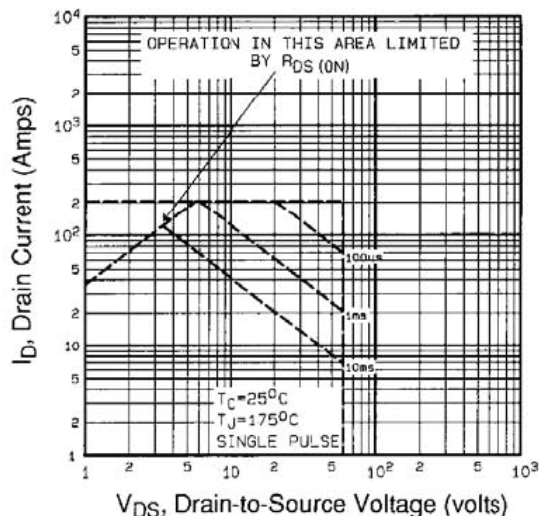
SPECIFICATIONS ($T_J = 25\text{ °C}$, unless otherwise noted)

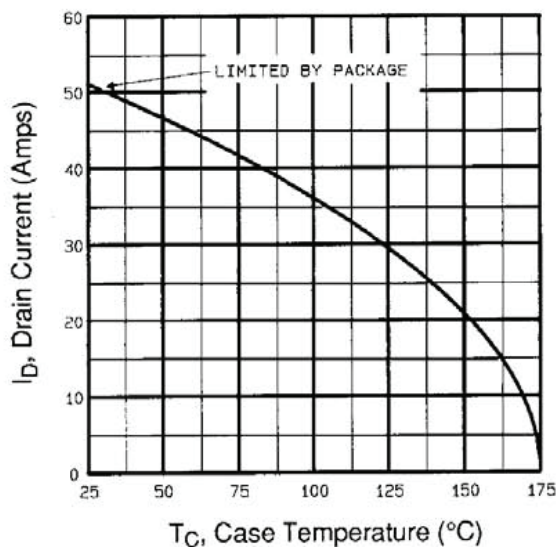
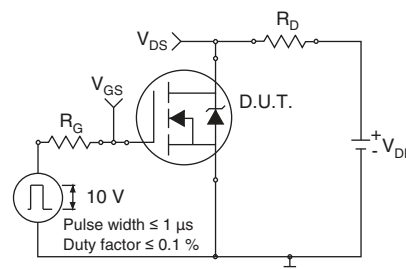
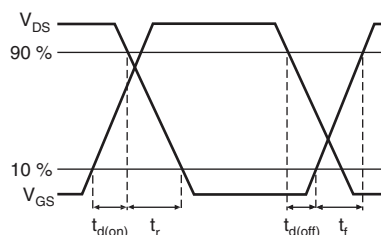
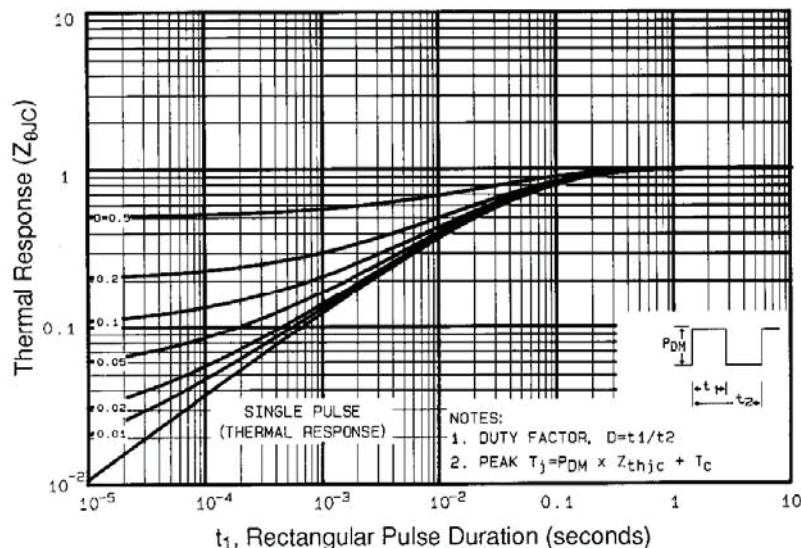
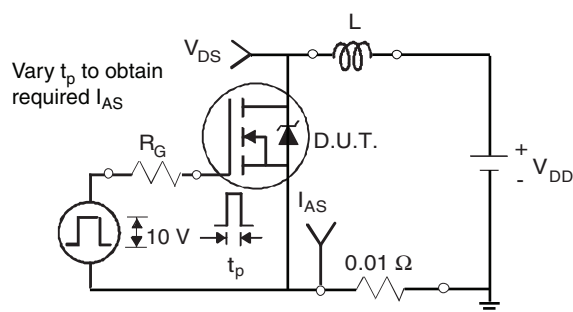
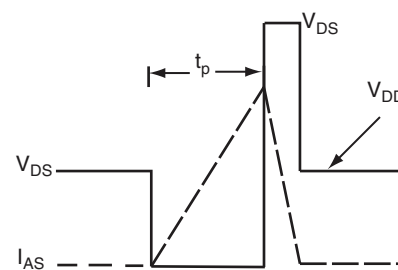
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|---------------------|---|--|------|-------|-----------|---------------------|
| Static | | | | | | | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$ | | 60 | - | - | V |
| V_{DS} temperature coefficient | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^\circ\text{C}$, $I_D = 1\text{ mA}$ | | - | 0.060 | - | V/ $^\circ\text{C}$ |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$ | | 2.0 | - | 4.0 | V |
| Gate-source leakage | I_{GSS} | $V_{GS} = \pm 20\text{ V}$ | | - | - | ± 100 | nA |
| Zero gate voltage drain current | I_{DSS} | $V_{DS} = 60\text{ V}$, $V_{GS} = 0\text{ V}$ | | - | - | 25 | μA |
| | | $V_{DS} = 48\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 125\text{ }^\circ\text{C}$ | | - | - | 250 | |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS} = 10\text{ V}$ | $I_D = 31\text{ A}^b$ | - | - | 0.028 | Ω |
| Forward transconductance | g_{fs} | $V_{DS} = 25\text{ V}$, $I_D = 31\text{ A}$ | | 15 | - | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C_{iss} | $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1.0\text{ MHz}$, see fig. 5 | | - | 1900 | - | pF |
| Output capacitance | C_{oss} | | | - | 920 | - | |
| Reverse transfer capacitance | C_{rss} | | | - | 170 | - | |
| Total gate charge | Q_g | $V_{GS} = 10\text{ V}$ | $I_D = 51\text{ A}$, $V_{DS} = 48\text{ V}$, see fig. 6 and 13 ^b | - | - | 67 | nC |
| Gate-source charge | Q_{gs} | | | - | - | 18 | |
| Gate-drain charge | Q_{gd} | | | - | - | 25 | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD} = 30\text{ V}$, $I_D = 51\text{ A}$, $R_g = 9.1\text{ }\Omega$, $R_D = 0.55\text{ }\Omega$, see fig. 10 ^b | | - | 14 | - | ns |
| Rise time | t_r | | | - | 110 | - | |
| Turn-off delay time | $t_{d(off)}$ | | | - | 45 | - | |
| Fall time | t_f | | | - | 92 | - | |
| Internal drain inductance | L_D | Between lead, 6 mm (0.25") from package and center of die contact  | | - | 4.5 | - | nH |
| Internal source inductance | L_S | | | - | 7.5 | - | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Continuous source-drain diode current | I_S | MOSFET symbol showing the integral reverse p - n junction diode  | | - | - | 50 | A |
| Pulsed diode forward current ^a | I_{SM} | | | - | - | 200 | |
| Body diode voltage | V_{SD} | $T_J = 25\text{ }^\circ\text{C}$, $I_S = 51\text{ A}$, $V_{GS} = 0\text{ V}^b$ | | - | - | 2.5 | V |
| Body diode reverse recovery time | t_{rr} | $T_J = 25\text{ }^\circ\text{C}$, $I_F = 51\text{ A}$, $dI/dt = 100\text{ A}/\mu\text{s}$ | | - | 120 | 180 | ns |
| Body diode reverse recovery charge | Q_{rr} | | | - | 0.53 | 0.80 | nC |
| Forward turn-on time | t_{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D) | | | | | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
b. Pulse width $\leq 300\text{ }\mu\text{s}$; duty cycle $\leq 2\%$

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, $T_C = 25^\circ\text{C}$

Fig. 3 - Typical Transfer Characteristics

Fig. 2 - Typical Output Characteristics, $T_C = 175^\circ\text{C}$

Fig. 4 - Normalized On-Resistance vs. Temperature


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage

Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Fig. 8 - Maximum Safe Operating Area


Fig. 9 - Maximum Drain Current vs. Case Temperature

Fig. 10a - Switching Time Test Circuit

Fig. 10b - Switching Time Waveforms

Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

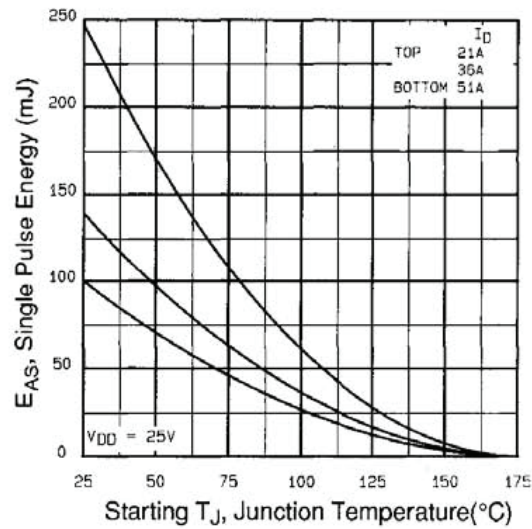


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

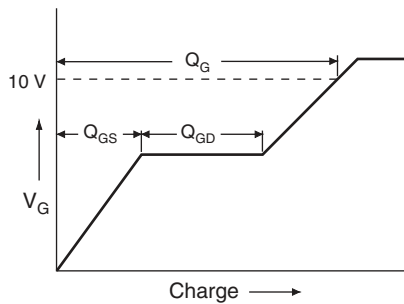


Fig. 13a - Basic Gate Charge Waveform

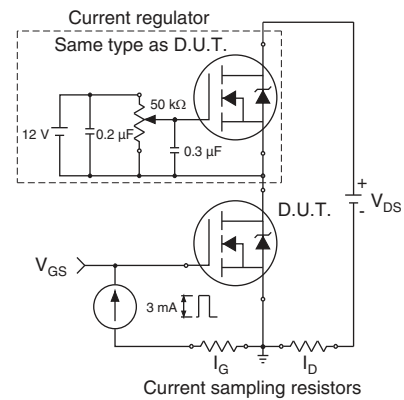
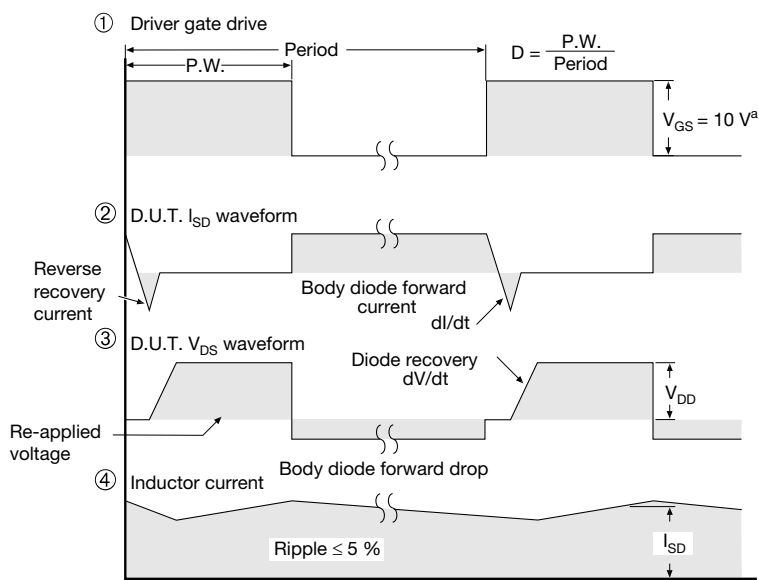
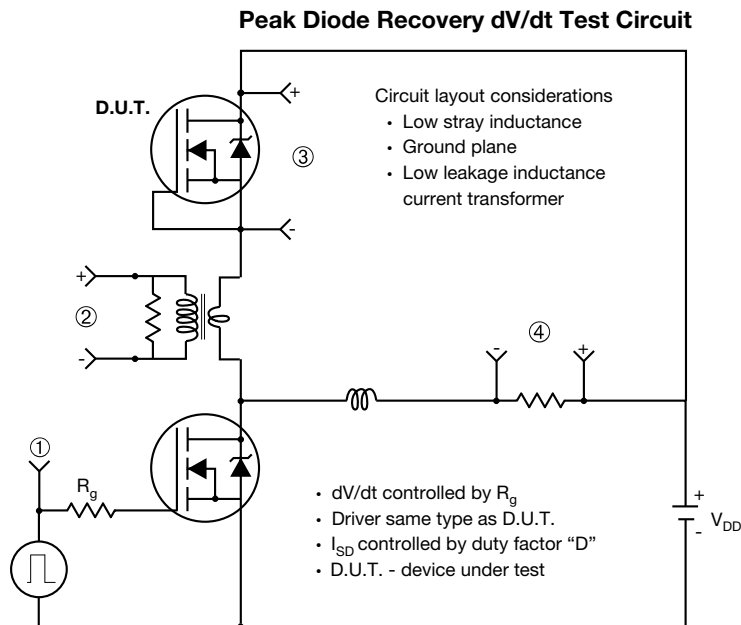


Fig. 13b - Gate Charge Test


Note

a. $V_{GS} = 5\text{ V}$ for logic level devices

Fig. 14 - For N-Channel

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